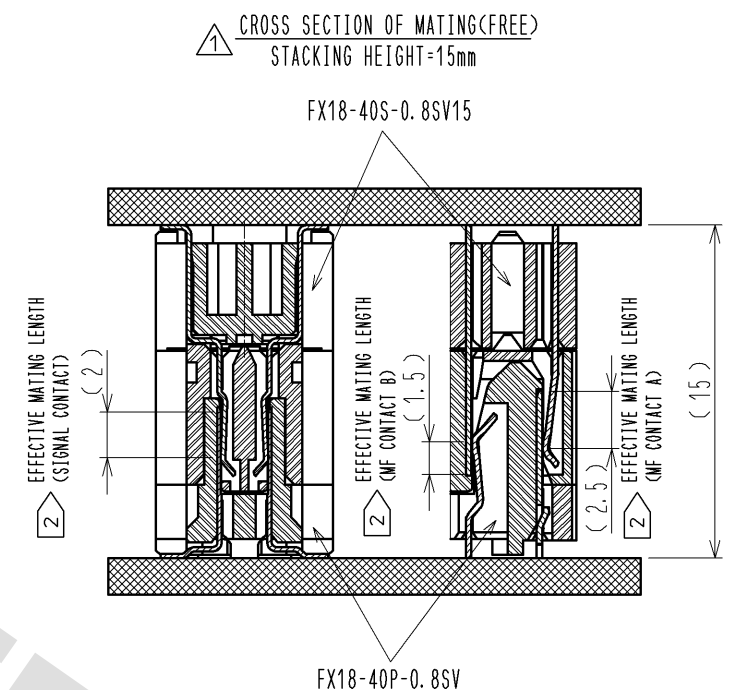
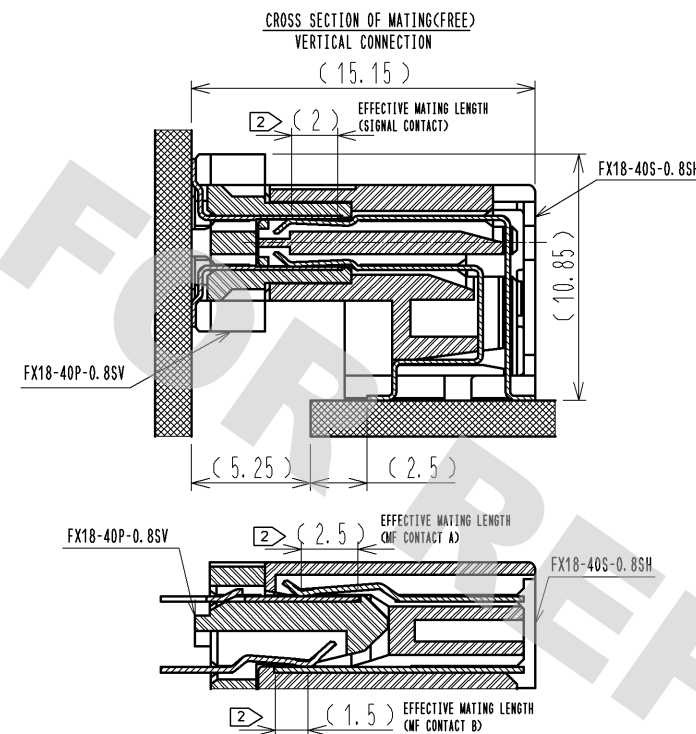
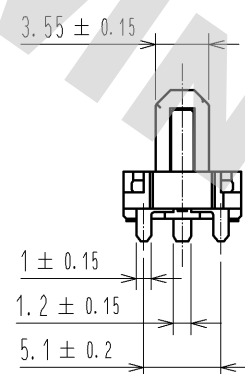
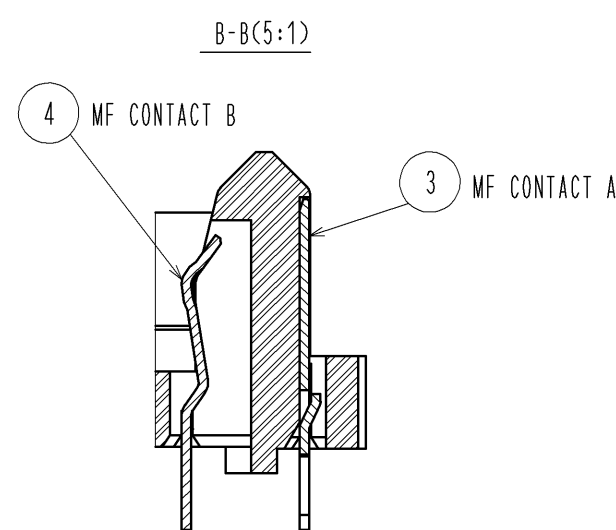
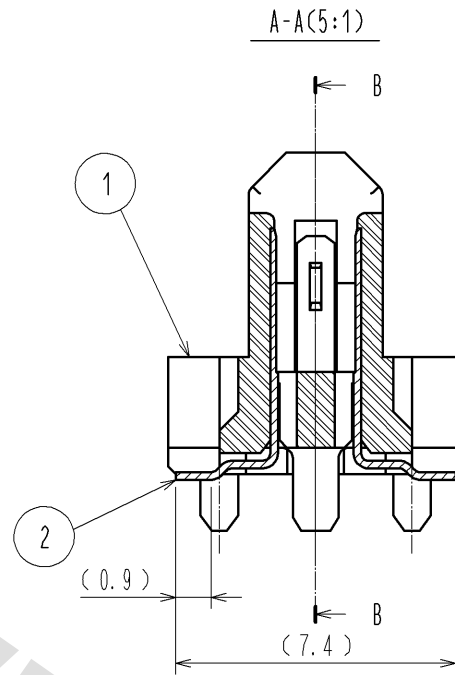
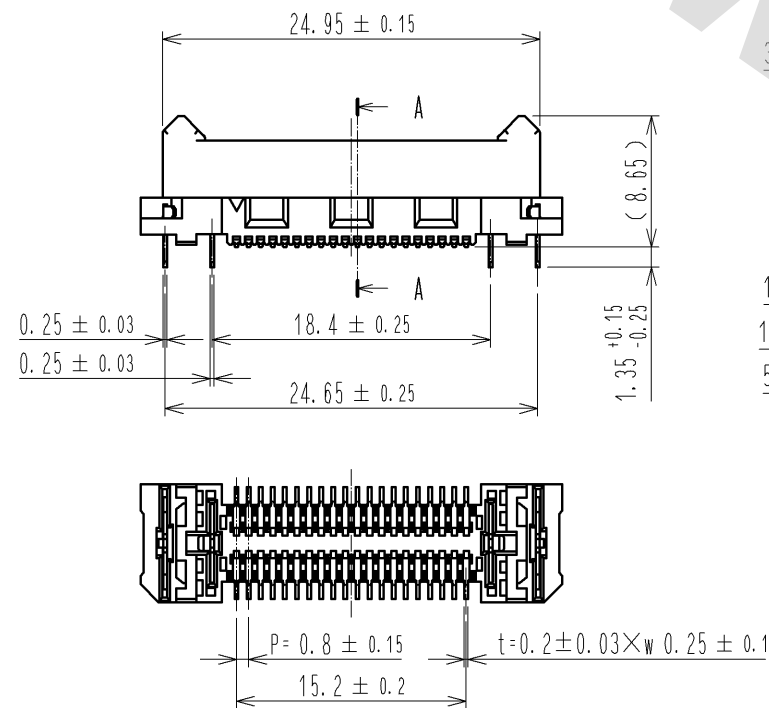
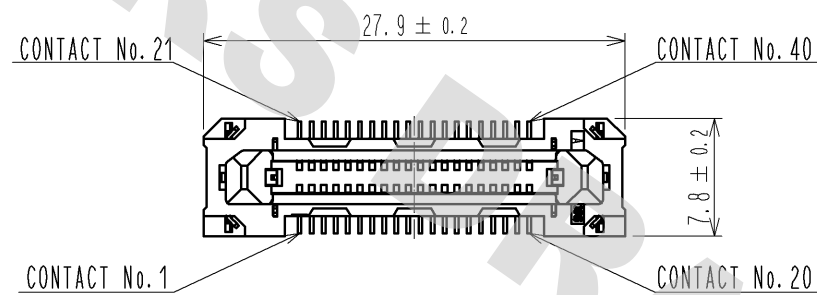


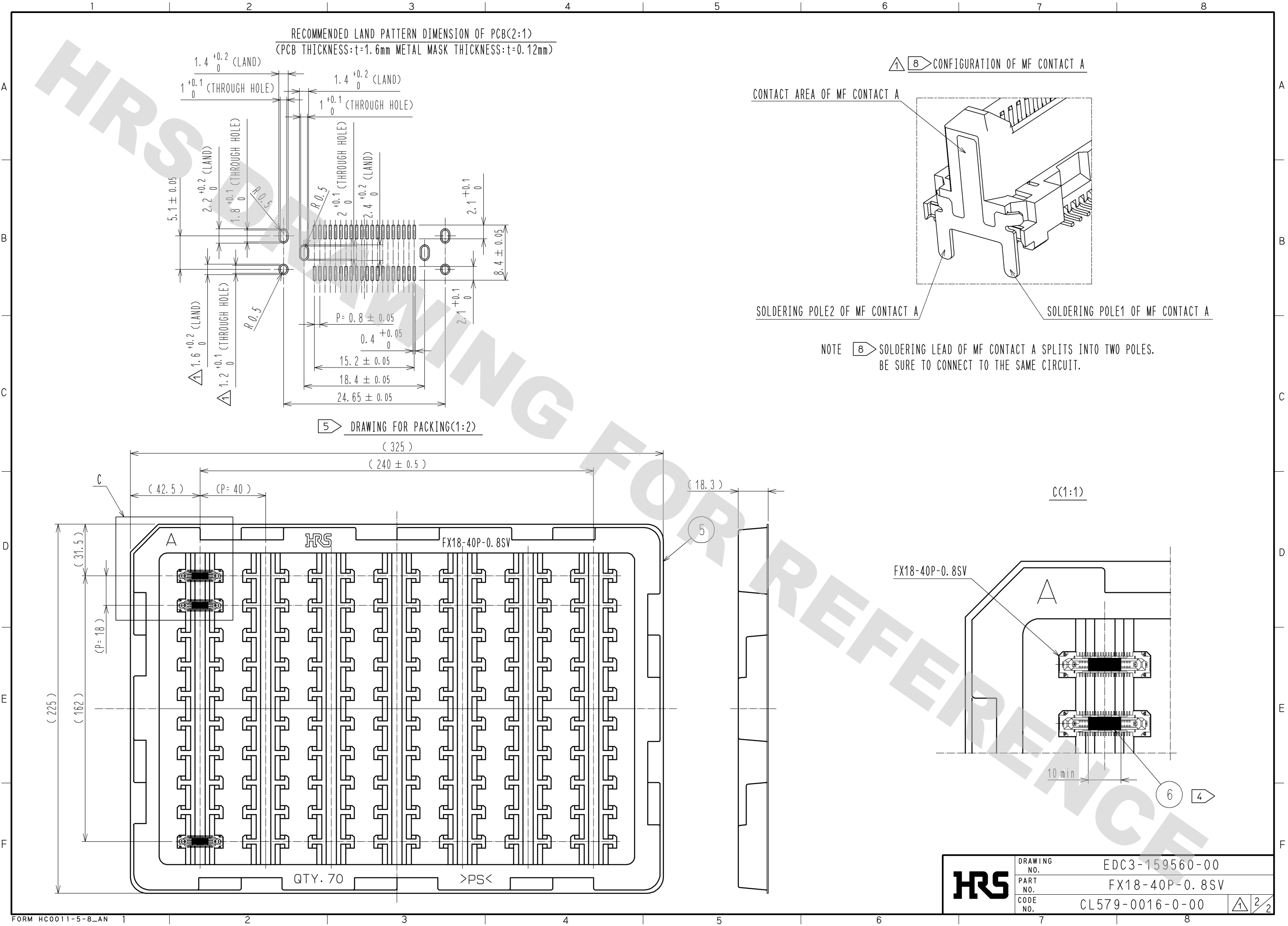
DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012



- NOTE 1 LEAD CO-PLANARITY IS 0.1mm MAX.
2 CONTACTS ARE 3 STEPS SEQUENTIAL. (MF CONTACT A=>SIGNAL CONTACT=>MF CONTACT B)
WHEN USING THIS SEQUENTIAL STRUCTURE, PLEASE AVOID ANGLED INSERTION.
3 MF CONTACT A AND MF CONTACT B CAN BE USED AS POWER SUPPLY CONTACT. (3A/PIN MAX)
4 IT SHOWS THE VACUUM PICKUP AREA. (SEE PAGE 2)
REMOVE THE MYLAR TAPE BEFORE MATING CONNECTORS.
5 THIS IS PACKAGED IN TRAY. (70pcs/TRAY)
6 BLEMISH AND HIT MARK CAN BE OCCURED THROUGH OUT THE MANUFACTURING PROCESS WHICH DOESN' T AFFECT QUALITY LEVEL.
7 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCES.

3	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm	6	POLYIMIDE	
		LEAD AREA:TIN-PLATING 1 μm			
		UNDER PLATING:NICKEL 1.3 μm			
2	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm	5	POLYSTYRENE	
		LEAD AREA:GOLD 0.03 μm			
		UNDER PLATING:NICKEL 1.3 μm			
1	POLYAMIDE	BLACK UL94V-0	4	PHOSPHOR BRONZE	CONTACT AREA:GOLD 0.1 μm
NO.		MATERIAL			LEAD AREA:TIN-PLATING 1 μm
		FINISH , REMARKS			UNDER PLATING:NICKEL 1.3 μm
UNITS		SCALE	COUNT	DESCRIPTION OF REVISIONS	DESIGNED
mm		2 : 1	4	DIS-F-005578	TH. SANO
HRS		APPROVED : HS. OKAWA	09.10.09	DRAWING NO.	EDC3-159560-00
		CHECKED : KI. HIROKAWA	09.10.09	PART NO.	FX18-40P-0.8SV
		DESIGNED : TH. SANO	09.10.09	CODE NO.	CL579-0016-0-00
		DRAWN : TH. SANO	09.10.09		
					DATE
					11.07.21
					CHECKED
					KI. HIROKAWA
					DATE
					11.07.21

DRAWING FOR REFERENCE: This is subject to change without notice
08/11/2012



HRS	DRAWING NO.	EDC3-159560-00
	PART NO.	FX18-40P-0.8SV
	CODE NO.	CL579-0016-0-00
		1/2